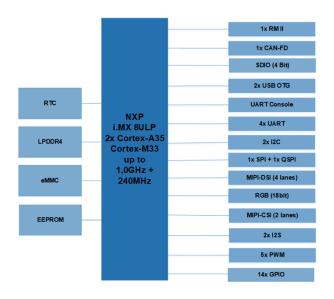
Characteristics

- NXP i.MX 8ULP Application Processor:
 2x Cortex®-A35 & Cortex®-M33
 Arm®TrustZone® architecture, EdgeLock® secure enclave
 Efficient in sleep and when running at full speed
- 2D GPU, 3D GPU (GCNanoUltra 3.1)
- Tensilica HIFI4 DSP + Fusion DSP
- LPDDR4, eMMC, EEPROM
- Real-Time Clock (RTC)
- Minimum availability: 2035

Block Diagramm



Description

The FS-8ULP-OSM-SF is fully compatible with SGET's OSM standard (Size S). It is a solder on module that offers a variety of interfaces, (i.e. LAN, USB, SDIO, CAN). The i.MX 8ULP processor is designed to deliver both low power and rich multimedia capabilities. It's not only possible to slow down or switch off the chip it is also designed to be efficient when running at full speed. EdgleLock Secure Enclave is perfect to meet the upcoming Cyber Resillence Act or U.S. Cyber Trust Mark. Displays can be connected via parallel RGB or MIPI-DSI interface. A MIPI-DSI to LVDS bridge can be used on the carrier board. Reference schematic is available and part of SKIT.

Due to the small size, the modules are ideal for applications, where space is limited. The single-sided assembly simplifies the implementation and is very robust against shock and vibration.





Operating Systems

F&S offers comprehensive software support for the operating system as well as various workshops*.

- Linux Yocto
- FreeRTOS for Cortex-M
- µPower Support
- MIPI-DSI display adaption
- Qt workshop
- Secure Boot workshop
- Asymetric Multiprocessing workshop

Starterkit

To facilitate the implementation of the module in the target appli-cation, F&S offers a Starterkit*, including:

- 2x OSM8ULP**
- Baseboard with MIPI-DSI to LVDS adapter
- 7" LVDS Touch-Display (1024 x 600) px
- Cable Kit
- Cooling Solution

Order Notations

OSM8ULP-V2I

standard, industrial:

i.MX8ULP: Dual Cortex-A35 @ 800MHz, 2GB RAM, 8GB eMMC, 18bit RGB, MIPI-DSI, EEPROM, RTC, -25°C +85°C, Linux

In addition to the standard version(s) listed on our homepage, F&S also offers and supports customer-specific configurations***.

OSM8ULP-SKIT-LIN

Interfaces:

Starterkit for FS 8ULP OSM-SF.

Technical Data (Quickfacts)

Power Supply: 5 VDC
Power Consumption: 2 W (typ.)
Processor: NXP i.MX 8ULP

Memory: LPDDR4 x32 **up to 2GB**

eMMC up to 64GB 64Kb EEPROM 1x RMII (Ethernet)

1x SDIO (4 bit) 2x USB 2.0 OTG

> 5x UART, 1x CAN, 18x GPIO 3x I2C, 2x SPI, QSPI, 2x I2S, 5x PWM, BL-PWM, PCIe

JTAG

I/O voltage: 1,8 V

Display: 18(24)bit RGB + MIPI-DSI (4-lane)

 Camera:
 MIPI-CSI (2-lane)

 RTC
 PCF85263ATL

 Temperature Range:
 -40°C ... +85°C

 Size (L x B x H):
 (30 x 30 x 2) mm

Weight: ≈ 5 g

* You can find detailed information on our website.

** 1x soldered onto an adapter which can be plugged onto the baseboard. 1x additional mechanical sample.



^{***} Please contact us for further information.